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September 2016

# FSA660—2:1 MIPI C-PHY (5.7 Gbps) 1-Data Lane Switch

#### **Features**

Switch Type: SPDT(3x)

Signal Types:MIPI, C-PHY

V<sub>CC</sub>: 1.5 to 5.0 V

Input Signals: 0 to 2.1 V

R<sub>ON</sub>: 5.4 Ω Typical
 ΔR<sub>ON</sub>: 0.1 Ω Typical
 R<sub>ON\_FLAT</sub>: 0.9 Ω Typical

I<sub>CCZ</sub>:1 μA Maximum
 I<sub>CC</sub>: 12 μA Typical
 O<sub>IRR</sub>: -28 dB Typical

Bandwidth: 5G Hz Typical

I<sub>L</sub>: -1.0 dB Typical
 Xtalk: -44 dB Typical
 C<sub>ON</sub>: 0.8 pF Typical

### **Description**

The FSA660 is a one-data-lane MIPI, C-PHY switch. This Single-Pole, Double-Throw (SPDT) switch is optimized for switching between two high-speed or low-power MIPI sources. The FSA660 is designed for the MIPI specification and allows connection to a CSI or DSI module.

## **Applications**

- Smart phones
- Tablets
- Laptops
- Displays

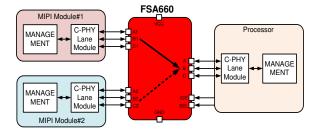


Figure 1. Typical Application

## **Ordering Information**

Part Number	Operating Temperature Range	Package	Top Mark	
FSA660TMX	-40 to +85°C	18-Lead, Quad, Ultra-ultrathin Molded Leadless Package (TMLP), 2.0 mm x 2.8 mm x 0.375 mm	LS	

## **Pin Descriptions**

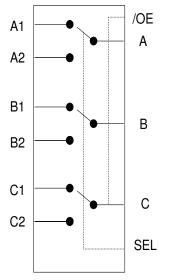


Figure 2. Analog Symbol

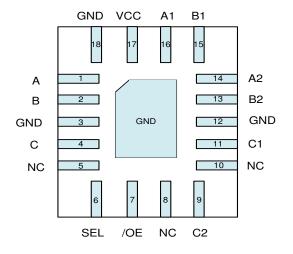


Figure 3. Pin Assignment(Top Through View)

## **Pin Definitions**

Pin Name	Description					
A1	1-Side Data Path A					
B1		1-Side	Data Path B			
C1		1-Side	Data Path C			
A2		2-Side	Data Path A			
B2		2-Side	Data Path B			
C2		2-Side	Data Path C			
Α		Commor	n Data Path A			
В		Common Data Path B				
С		Commor	n Data Path C			
/OE		Outp	ut Enable			
SEL	Control Pin	SEL=0	A=A1,B=B1,C=C1			
SEL	Control Pin	SEL=1	A=A2,B=B2,C=C2			
VCC	Power					
GND	Ground					
NC	No Connect					

## **Truth Table**

SEL	/OE	Function
HIGH	LOW	A=A2,B=B2,C=C2
LOW	LOW	A=A1,B=B1,C=C1
X	HIGH	A,B,C Data Ports High Impedance

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
V <sub>CC</sub>	Supply Voltage		-0.5	6.0	V
V <sub>CNTRL</sub>	DC Input Voltage (SEL, /OE) <sup>(1)</sup>		-0.5	V <sub>CC</sub>	V
V <sub>SW</sub>	DC Switch I/O Voltage <sup>(1,2)</sup>		-0.3	2.1	V
I <sub>IK</sub>	DC Input Diode Current		-50		mA
I <sub>sw</sub>	DC Switch Current			25	mA
T <sub>STG</sub>	Storage Temperature		-65	+150	°C
MSL	Moisture Sensitivity Level (JEDEC J-STD-020A)			1	
	Human Body Model, JEDEC: JESD22-A114	All Pins	2		
ESD	IEC 61000-2-4, Level 4, for Switch Pins	Contact	8		kV
E9D	Air		15		,
	Charged Device Model, JESD22-C101		1		

#### Notes:

- 1. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.
- 2. V<sub>SW</sub> refers to analog data switch paths.

## **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter		Min.	Max.	Unit
V <sub>CC</sub>	Supply Voltage		1.5	5.0	V
V <sub>CNTRL</sub>	Control Input Voltage (SEL, /OE) <sup>(3)</sup>		0	5.0	V
V <sub>SW</sub>	Switch I/O Voltage  HS Mode  LP Mode		0	0.54	V
			0	1.3	
T <sub>A</sub>	Operating Temperature		-40	+85	°C

#### Note:

3. The control inputs must be held HIGH or LOW; they must not float.

## **DC and Transient Characteristics**

All typical values are at T<sub>A</sub>=25°C unless otherwise specified.

O. mah al	Parameter	Condition	V <sub>cc</sub> (V)	T <sub>A</sub> = -40°C to +85°C			11
Symbol				Min.	Тур.	Max.	Unit
VıK	Clamp Diode Voltage SEL, /OE	I <sub>IN</sub> =-18 mA	1.5	-1.2		-0.6	V
lıĸ	Clamp Diode Current (Switch Pins)	V <sub>IN</sub> =-0.3 V	0			18	μΑ
		SEL, /OE	1.5	1.3			V
$V_{IH}$	Control Input Voltage High	SEL, /OE	3.6	1.4			V
		SEL, /OE	5.0	1.5			V
		SEL, /OE	1.5			0.4	V
$V_{IL}$	Control Input Voltage Low	SEL, /OE	3.6			0.4	V
		SEL, /OE	5.0			0.4	V
I <sub>IN</sub>	Control Input Leakage	V <sub>SW</sub> = 0 to 2.0 V V <sub>CNTRL</sub> =0 to V <sub>CC</sub>	5.0	-500		500	nA
l <sub>OZ</sub>	Off-State Leakage for Open Data Paths	$V_{SW}$ = 0.0 $\leq$ DATA $\leq$ 2.0 $V$	5.0	-500		500	nA
I <sub>CL</sub>	On-State Leakage for Closed Data Paths <sup>(4)</sup>	$V_{SW}$ = 0.0 $\leq$ DATA $\leq$ 2.0 $V$	5.0	-500		500	nA
I <sub>OFF</sub>	Power-Off Leakage Current (All I/O Ports)	V <sub>SW</sub> = 0.0 V to 2.0 V	0	-500		500	nA
R <sub>ON</sub>	Switch On Resistance	V <sub>SW</sub> = 0 V, I <sub>ON</sub> =-8 mA	1.5		5.4	8.0	Ω
$\Delta R_{\text{ON}}$	Difference in R <sub>ON</sub> Between Positive-Negative	V <sub>SW</sub> = 0 V, I <sub>ON</sub> =-8 mA,	1.5		0.1		Ω
R <sub>ONF_FLAT</sub>	Flatness for R <sub>ON</sub>	$V_{SW}$ = 0 $\leq$ DATA $\leq$ 2.0 V, $I_{ON}$ =-8 mA	1.5		0.9		Ω
I <sub>CC</sub>	Quiescent Supply Current	$V_{/OE}$ =0, $V_{SEL}$ =0 or $V_{CC}$ , $I_{OUT}$ =0	5.0		12	30	μΑ
I <sub>CCZ</sub>	Quiescent Supply Current (High Impedance)	$V_{SEL}=X, V_{/OE}=V_{CC},$ $I_{OUT}=0$	5.0			1	μΑ
I <sub>CCT</sub>	Increase in Quiescent Supply Current	V <sub>SEL</sub> =X, V <sub>/OE</sub> =1.5 V	5.0		5	15	μΑ

#### Note:

4. For this test, the data switch is closed with the respective switch pin floating.

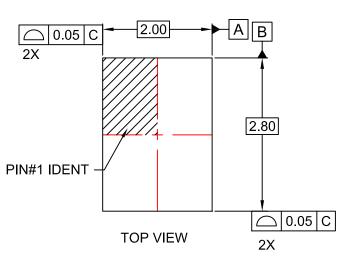
## **AC Electrical Characteristics**

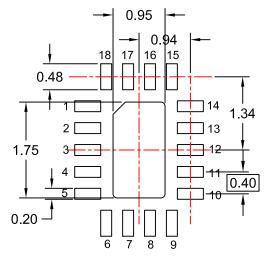
All typical value are for  $V_{\text{CC}}$  =3.6 V and  $T_{\text{A}}$ =25°C unless otherwise specified.

Cumbal	Davamatav	Condition	V <sub>cc</sub> (V)	T <sub>A</sub> = -40°C to +85°C			11
Symbol	Parameter			Min.	Тур.	Max.	Unit
ton	Turn-On Time, SEL to Output	$R_L$ =50 $\Omega$ , $C_L$ =0 pF, $V_{SW}$ =0 V, $V_{SW}$ =0.6 V	1.5 to 5.0 V		350	600	ns
t <sub>OFF</sub>	Turn-Off Time, SEL to Output	$\begin{array}{c} R_L{=}50~\Omega,C_L{=}0~pF,V_{SW}{=}0~V,\\ V_{SW}{=}3.3~V \end{array}$	1.5 to 5.0 V		125	300	ns
t <sub>PD</sub>	Propagation Delay <sup>(5)</sup>	$C_L=$ , $C_L=0$ pF, $R_L=50$ $\Omega$ ,	1.5 to 5.0 V		0.25		ns
t <sub>BBM</sub>	Break-Before-Make <sup>(5)</sup>	$R_L$ =50 $\Omega$ , $C_L$ =0 pF, $V_{SW1}$ =0.6 V, $V_{SW2}$ = -0.6 V,	1.5 to 5.0 V	100		350	ns
t <sub>PEN</sub>	Enable Time, /OE to Output	R <sub>L</sub> =50 Ω, C <sub>L</sub> =0 pF, V <sub>SW</sub> =0.6 V	1.5 to 5.0 V		60	150	μs
t <sub>PDISEN</sub>	Disable Time, /OE to Output	$R_L=50 \Omega$ , $C_L=0$ pF, $V_{SW}=0.6$ V	1.5 to 5.0 V		35	240	ns
O <sub>IRR</sub>	Off Isolation <sup>(5)</sup>	$V_S$ =0 dBm, R=50 $\Omega$ , f=2.5 GHz	3.6 V		-28		dB
Xtalk	Channel Crosstalk <sup>(5)</sup>	$V_S$ =0 dBm, R=50 $\Omega$ , f=2.5 GHz	3.6 V		-44		dB
IL	Insertion Loss <sup>(5)</sup>	$\begin{array}{c} V_S{=}0 \text{ dBm, f=2.5 GHz,} \\ R_L{=}50 \Omega, C_L{=}0 \text{ pF} \end{array}$	3.6V		-1.0		dB
BW	-3 db Bandwidth <sup>(5)</sup>	$V_{\text{IN}}=1$ $V_{\text{pk-pk}}$ , $R_{\text{L}}=50$ $\Omega$ , $C_{\text{L}}=0$ pF (All Data Paths)	3.6 V		5		GHz
t <sub>SK(P)</sub>	Skew of Transitions of the Output <sup>(5)</sup>	$$\rm R_{PU}{=}50~\Omega$ to $\rm V_{CC},~f{=}2.5~GHz,$ $\rm C_{L}{=}0~pF$	3.6 V		6		ps
C <sub>IN</sub>	Control Pin Input Capacitance <sup>(5)</sup>	V <sub>CC</sub> =0 V, f=1 MHz			2.7		pF
Con	On Capacitance <sup>(5)</sup>	V <sub>CC</sub> =3.3 V, f=2.5 GHz			0.8		pF
C <sub>OFF</sub>	Off Capacitance <sup>(5)</sup>	V <sub>CC</sub> =3.3 V, f=2.5 GHz			0.6		pF

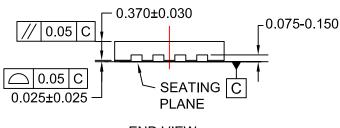
#### Note:

5. Guaranteed by characterization and design. Not production tested.





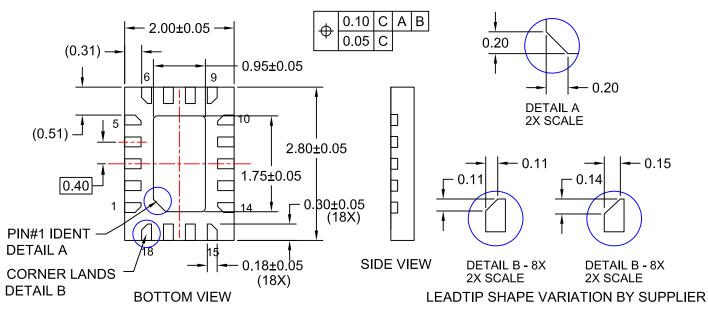
LAND PATTERN RECOMMENDATION



**END VIEW** 

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- D. LAND PATTERN RECOMMENDATION IS A FAIRCHILD DESIGN.
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